

FORM 100 VERSION 1.0 (October 27, 1990)

Attorney Docket No. 020569-01802
(P203-1318B-US)

DECLARATION

SOLE/JOINT INVENTOR
ORIGINAL/SUBSTITUTE/CIP

As a below named inventor, I hereby declare that: my residence, post office address, and citizenship are as stated below next to my name. I believe I am a joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled:

METHOD OF TREATING SUBTERRANEAN FORMATIONS USING MIXED DENSITY PROPPANTS OR SEQUENTIAL PROPPANT STAGES

as described in the specification of patent Application Serial No. 10/803,258 of March 18, 2004.

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above; that I do not know and do not believe the same was ever known or used in the United States of America before my or our invention thereof, or patented or described in any printed publication in any country before my or our invention thereof or more than one year prior to this application; that the invention has not been patented or made the subject of an inventor's certificate issued before the date of this application in any country foreign to the United States of America on an application filed by me or my legal representative or assigns more than twelve months prior to this application; and that I acknowledge the duty to disclose information of which I am aware which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations § 1.56(a). Such information is material when it is not cumulative to information already of record or being made of record in the application, and

- (1) it establishes, by itself or in combination with other information, a prima facie case of unpatentability of a claim; or
- (2) it refutes, or is inconsistent with, a position the applicant has taken or may take in:
 - (i) opposing an argument of unpatentability relied on by the Office, or
 - (ii) asserting an argument of patentability.

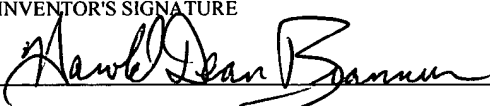
I hereby claim the benefit under Title 35 United States Code § 120 of any United States application(s) listed below and, insofar as any subject matter of any claim of this application is not disclosed in the prior United States Application, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations § 1.56(a) which occurred between the filing date of the prior application and the national PCT international filing date of this application:

U.S. Patent Application Serial No. 60/455,717 filed on March 18, 2003
U.S. Patent Application Serial No. 60/508,822 filed on October 3, 2003

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Please direct all written communications to the address listed below: All telephone calls should be directed to John Wilson Jones at (713) 226-1142.

John Wilson Jones
Attn: IP Docketing Clerk
Locke, Liddell & Sapp LLP
600 Travis, Suite 3400
Houston, Texas 77002
(713) 226-1142

FULL NAME OF SOLE OR FIRST INVENTOR	INVENTOR'S SIGNATURE	DATE
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FORM 100 VER. 5.0 (10/1/99) (October 27, 1990)

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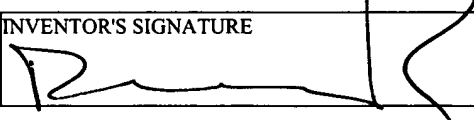
FULL NAME OF SIXTH INVENTOR	INVENTOR'S SIGNATURE	DATE
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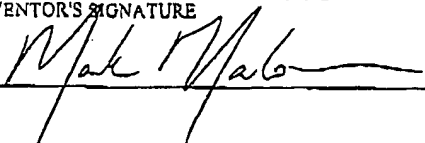
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